



Product data sheet

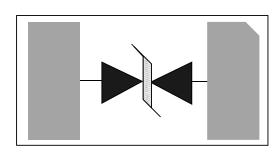
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RCLAMP0531T.TCT-MS HF 🐼

Semiconductor Compiance





SLP1006P2T

Schematic & PIN Configuration

Features

- 100Watts peak pulse power (tp = $8/20\mu s$)
- Bidirectional configurations
- Solid-state silicon-avalanche technology
- Low clamping voltage
- Low leakage current
- Low capacitance (Cj=0.25pF typ.)
- Protection one data/power line to:
- IEC 61000-4-2 \pm 20kV contact \pm 20kV air
- IEC 61000-4-4 (EFT) 40A (5/50ns)
- IEC 61000-4-5 (Lightning) 4A (8/20µs)

Applications

- Cell Phone Handsets and Accessories
- Microprocessor based equipment
- Personal Digital Assistants (PDA's)
- Notebooks, Desktops, and Servers
- Portable Instrumentation

Mechanical Data

- SLP1006P2T
- Molding compound flammability rating: UL 94V-0
- Packaging: Tape and Reel
- RoHS/WEEE Compliant

Absolute Maximum Rating

Rating	Symbol	Value	Units
Peak Pulse Power ($t_p = 8/20 \mu s$)	P _{PP}	100	Watts
Peak Pulse Current (t _p =8/20µs) (note1)	I _{pp}	4.0	А
ESD per IEC 61000-4-2 (Air) ESD per IEC 61000-4-2 (Contact)	V _{ESD}	20 20	kV
Lead Soldering Temperature	TL	260(10seconds)	°C
Junction Temperature	TJ	-55 to + 125	°C
Storage Temperature	T _{stg}	-55 to + 125	°C





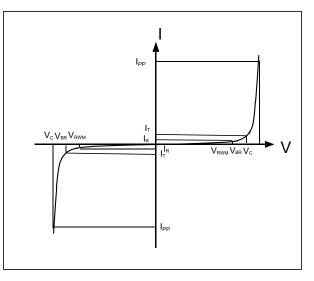
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Electrical Characteristics

Parameter	Symbol	Conditions	Min	Typical	Max	Units
Reverse Stand-Off Voltage	V _{RWM}				5.0	V
Reverse Breakdown Voltage	V _{BR}	I _T =1mA	6.0			V
Reverse Leakage Current	I _R	V _{RWM} =5V,T=25°C			100	nA
Peak Pulse Current	I_{PP}	tp =8/20µs			4.0	А
Clamping Voltage	Vc	Ipp=4A,tp=8/20µs			25	V
Junction Capacitance	Cj	$V_R = 0V, f = 1MHz$		0.25	0.5	pF

Electrical Parameters (TA = 25°C unless otherwise noted)

Symbol	Parameter	
Ipp	Maximum Reverse Peak Pulse Current	
Vc	Clamping Voltage @ IPP	
VRWM	Working Peak Reverse Voltage	
Ir	Maximum Reverse Leakage Current @ VRWM	
VBR	Breakdown Voltage @ IT	
Іт	Test Current	



Note:. 8/20µs pulse waveform.





Typical Characteristics

Figure 1: Peak Pulse Power vs. Pulse Time

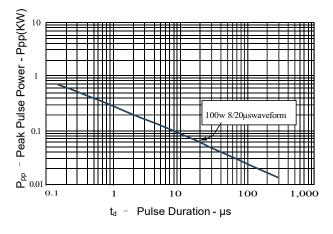


Figure3: Pulse Waveform

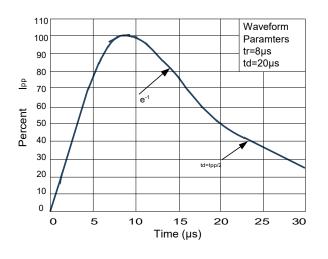
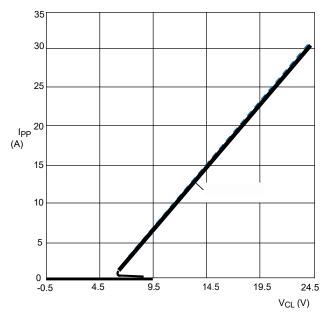


Figure5: Positive Clamping voltage (TLP)



Percent of Rated Power for $I_{\mbox{\scriptsize pp}}$ ⁰ o Ambient Temperature - T_A (℃)

Figure 2: Power Derating Curve



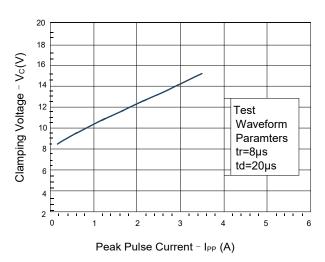
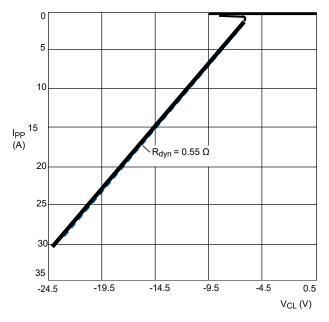


Figure5: Negative Clamping voltage (TLP)

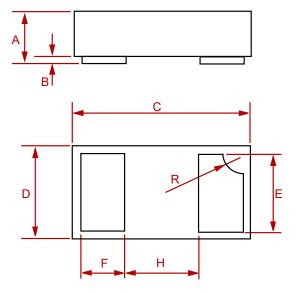




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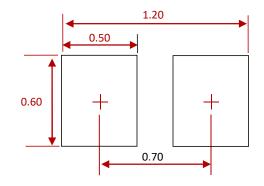
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PACKAGE MECHANICAL DATA



Dim	Inches		Millimeters	
Dim	MIN	MAX	MIN	МАХ
А	0.0125	0.02	0.32	0.52
В	0.000	0.002	0.00	0.05
С	0.037	0.043	0.95	1.080
D	0.022	0.027	0.55	0.680
E	0.016	0.024	0.40	0.60
F	0.008	0.012	0.20	0.30
н	0.015Typ.		0.40Тур.	
R	0.001	0.005	0.05	0.15

Suggested Pad Layout



NOTES:

- 1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
- 2. THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY.
 - CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR COMPANY'S MANUFACTURING GUIDELINES ARE MET.

REEL SPECIFICATION

P/N	PKG	QTY
RCLAMP0531T.TCT-MS	SLP1006P2T	3000



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